

Data sheet acquired from Harris Semiconductor SCHS250A

August 1998 - Revised May 2000

9-Bit Odd/Even Parity Generator/Checker

Features

- Buffered Inputs
- Typical Propagation Delay
 - 10ns at $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 50pF$
- Exceeds 2kV ESD Protection per MIL-STD-883, Method 3015
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Speed of Bipolar FAST[™]/AS/S with Significantly Reduced Power Consumption
- Balanced Propagation Delays
- AC Types Feature 1.5V to 5.5V Operation and Balanced Noise Immunity at 30% of the Supply
- ±24mA Output Drive Current
 - Fanout to 15 FAST™ ICs
 - Drives 50Ω Transmission Lines

Description

The 'AC280 and 'ACT280 are 9-bit odd/even parity generator/checkers that utilize Advanced CMOS Logic technology. Both even and odd parity outputs are available for checking or generating parity for words up to nine bits long. Even parity is indicated (ΣE output is HIGH) when an even number of

data inputs is HIGH. Odd parity is indicated (Σ O output is HIGH) when an odd number of data inputs is HIGH. Parity checking for words larger than nine bits can be accomplished by tying the Σ E output to any input of an additional 'AC280, 'ACT280 parity checker.

Ordering Information

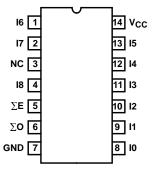
| PART NUMBER | TEMP. RANGE (^O C) | PACKAGE |
|----------------|--|--------------|
| CD54AC280F3A | -55 to 125 | 14 Ld CERDIP |
| CD74AC280E | 0 to 70 ^o C, -40 to 85, -55 to 125 | 14 Ld PDIP |
| CD74AC280M | 0 to 70 ^o C, -40 to 85, -55 to 125 | 14 Ld SOIC |
| CD54ACT280F3A | -55 to 125 | 14 Ld CERDIP |
| CD74ACT280E | 0 to 70°C, -40 to 85, -55 to 125 | 14 Ld PDIP |
| CD74ACT280M | 0 to 70°C, -40 to 85, -55 to 125 | 14 Ld SOIC |

NOTES:

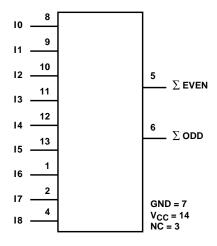
- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local TI sales office or customer service for ordering information.

Pinout

CD54AC280, CD54ACT280 (CERDIP) CD74AC280, CD74ACT280 (PDIP, SOIC) TOP VIEW



Functional Diagram



CD54/74AC280, CD54/74ACT280

Absolute Maximum Ratings

| DC Supply Voltage, V _{CC} 0.5V to 6V |
|---|
| DC Input Diode Current, I _{IK} |
| For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ |
| DC Output Diode Current, I _{OK} |
| For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ |
| DC Output Source or Sink Current per Output Pin, IO |
| For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ |
| DC V _{CC} or Ground Current, I _{CC or} I _{GND} (Note 3) ±100mA |

Thermal Information

| Thermal Resistance (Typical, Note 5) | θ _{JA} (^o C/W) |
|--|-------------------------------------|
| PDIP Package | |
| SOIC Package | · |
| Maximum Junction Temperature (Plastic Package) | 150 ⁰ C |
| Maximum Storage Temperature Range | 65°C to 150°C |
| Maximum Lead Temperature (Soldering 10s) | 300°C |
| | |

Operating Conditions

| Temperature Range, T _A 55°C to 125°C Supply Voltage Range, V _{CC} (Note 4) |
|--|
| AC Types1.5V to 5.5V |
| ACT Types |
| DC Input or Output Voltage, V _I , V _O 0V to V _{CC} |
| Input Rise and Fall Slew Rate, dt/dv |
| AC Types, 1.5V to 3V 50ns (Max) |
| AC Types, 3.6V to 5.5V |
| ACT Types, 4.5V to 5.5V |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- 3. For up to 4 outputs per device, add $\pm 25 \text{mA}$ for each additional output.
- 4. Unless otherwise specified, all voltages are referenced to ground.
- 5. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

DC Electrical Specifications

| | | TEST CONDITIONS V _I (V) I _O (mA) | | v _{cc} | 25°C | | -40°C TO 85°C | | -55°C TO 125°C | | |
|---------------------------|-----------------|---|--------------------|-----------------|------|------|------------------|------|-------------------|------|-------|
| PARAMETER | SYMBOL | | | (V) | MIN | MAX | MIN | MAX | MIN | MAX | UNITS |
| AC TYPES | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 1.5 | 1.2 | - | 1.2 | - | 1.2 | - | V |
| | | | | 3 | 2.1 | - | 2.1 | - | 2.1 | - | V |
| | | | | 5.5 | 3.85 | - | 3.85 | - | 3.85 | - | V |
| Low Level Input Voltage | V _{IL} | - | - | 1.5 | - | 0.3 | - | 0.3 | - | 0.3 | V |
| | | | | 3 | - | 0.9 | - | 0.9 | - | 0.9 | V |
| | | | | 5.5 | - | 1.65 | - | 1.65 | - | 1.65 | V |
| High Level Output Voltage | V _{OH} | V _{IH} or V _{IL} | -0.05 | 1.5 | 1.4 | - | 1.4 | - | 1.4 | - | V |
| | | | -0.05 | 3 | 2.9 | - | 2.9 | - | 2.9 | - | V |
| | | | -0.05 | 4.5 | 4.4 | - | 4.4 | - | 4.4 | - | V |
| | | | -4 | 3 | 2.58 | - | 2.48 | - | 2.4 | - | V |
| | | | -24 | 4.5 | 3.94 | - | 3.8 | - | 3.7 | - | V |
| | | | -75 (Note 6, 7) | 5.5 | - | - | 3.85 | - | - | - | V |
| | | | -50 (Note 6, 7) | 5.5 | - | - | - | - | 3.85 | - | V |

CD54/74AC280, CD54/74ACT280

DC Electrical Specifications (Continued)

| | | 1 | ST ITIONS | Voc | V _{CC} 25°C | | | C TO | | C TO 5°C | |
|---|------------------|--|--------------------|---------------|----------------------|------|------|------|------|-------------|-------|
| PARAMETER | SYMBOL | V _I (V) I _O (mA) | | (v) | MIN | MAX | MIN | MAX | MIN | MAX | UNITS |
| Low Level Output Voltage | V_{OL} | V _{IH} or V _{IL} | 0.05 | 1.5 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.05 | 3 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.05 | 4.5 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 12 | 3 | - | 0.36 | - | 0.44 | - | 0.5 | V |
| | | | 24 | 4.5 | - | 0.36 | - | 0.44 | - | 0.5 | V |
| | | | 75 (Note 6, 7) | 5.5 | - | - | - | 1.65 | - | - | V |
| | | | 50 (Note 6, 7) | 5.5 | - | - | - | - | - | 1.65 | V |
| Input Leakage Current | lį | V _{CC} or GND | - | 5.5 | - | ±0.1 | - | ±1 | - | ±1 | μА |
| Quiescent Supply Current MSI | I _{CC} | V _{CC} or GND | 0 | 5.5 | - | 8 | - | 80 | - | 160 | μА |
| ACT TYPES | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 4.5 to 5.5 | 2 | - | 2 | - | 2 | - | V |
| Low Level Input Voltage | V _{IL} | - | - | 4.5 to 5.5 | - | 0.8 | - | 0.8 | - | 0.8 | V |
| High Level Output Voltage | V _{OH} | V _{IH} or V _{IL} | -0.05 | 4.5 | 4.4 | - | 4.4 | - | 4.4 | - | V |
| | | | -24 | 4.5 | 3.94 | - | 3.8 | - | 3.7 | - | V |
| | | | -75 (Note 6, 7) | 5.5 | - | - | 3.85 | - | - | - | V |
| | | | -50 (Note 6, 7) | 5.5 | - | - | - | - | 3.85 | - | V |
| Low Level Output Voltage | V_{OL} | V _{IH} or V _{IL} | 0.05 | 4.5 | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 24 | 4.5 | - | 0.36 | - | 0.44 | - | 0.5 | V |
| | | | 75 (Note 6, 7) | 5.5 | - | - | - | 1.65 | - | - | V |
| | | | 50 (Note 6, 7) | 5.5 | - | - | - | - | - | 1.65 | V |
| Input Leakage Current | l _l | V _{CC} or GND | - | 5.5 | - | ±0.1 | - | ±1 | - | ±1 | μА |
| Quiescent Supply Current MSI | Icc | V _{CC} or GND | 0 | 5.5 | - | 8 | - | 80 | - | 160 | μΑ |
| Additional Supply Current per Input Pin TTL Inputs High 1 Unit Load | Δl _{CC} | V _{CC} -2.1 | - | 4.5 to 5.5 | - | 2.4 | - | 2.8 | - | 3 | mA |

NOTES:

- 6. Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
- 7. Test verifies a minimum 50Ω transmission-line-drive capability at 85° C, 75Ω at 125° C.

ACT Input Load Table

| INPUT | UNIT LOAD |
|-------|-----------|
| All | 1.43 |

NOTE: Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., 2.4mA max at 25°C.

CD54/74AC280, CD54/74ACT280

Switching Specifications Input t_r , t_f = 3ns, C_L = 50pF (Worst Case)

| | | | -40° | C TO 85° | С | -55 | | | |
|--|-------------------------------------|---------------------|------|----------|------|-----|-----|------|-------|
| PARAMETER | SYMBOL | V _{CC} (V) | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| AC TYPES | | | | | • | | | • | |
| Propagation Delay, | t _{PLH} , t _{PHL} | 1.5 | - | - | 239 | - | - | 263 | ns |
| Any Input to ΣO | | 3.3 (Note 9) | 7.5 | - | 26 | 7.3 | - | 29 | ns |
| | | 5 (Note 10) | 5.4 | - | 19.1 | 5.3 | - | 21 | ns |
| Propagation Delay, | t _{PLH} , t _{PHL} | 1.5 | - | - | 227 | - | - | 250 | ns |
| Any Input to ∑E | | 3.3 | 7.2 | - | 25 | 7 | - | 28 | ns |
| | | 5 | 5.2 | - | 18.2 | 5 | - | 20 | ns |
| Input Capacitance | Cl | - | - | - | 10 | - | - | 10 | pF |
| Power Dissipation Capacitance | C _{PD} (Note 11) | - | - | 115 | - | - | 115 | - | pF |
| ACT TYPES | | | | • | • | | | • | |
| Propagation Delay, Any Input to Σ O | t _{PLH} , t _{PHL} | 5 (Note 10) | 5.6 | - | 19.6 | 5.4 | - | 21.6 | ns |
| Propagation Delay, Any Input to ΣE | t _{PLH} , t _{PHL} | 5 | 5.6 | - | 19.6 | 5.4 | - | 21.6 | ns |
| Input Capacitance | C _I | - | - | - | 10 | - | - | 10 | pF |
| Power Dissipation Capacitance | C _{PD} (Note 11) | - | - | 115 | - | - | 115 | - | pF |

NOTES:

- 8. Limits tested 100%
- 9. 3.3V Min is at 3.6V, Max is at 3V.
- 10. 5V Min is at 5.5V, Max is at 4.5V.
- 11. C_{PD} is used to determine the dynamic power consumption per package.

AC:
$$P_D = V_{CC}^2 f_i (C_{PD} + C_L)$$

AC: $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ + $V_{CC} \Delta I_{CC}$ where f_i = input frequency, C_L = output load capacitance, V_{CC} = supply voltage.

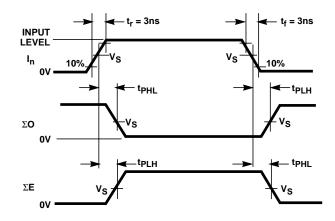
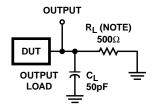


FIGURE 1.



NOTE: For AC Series Only: When V_{CC} = 1.5V, R_L = 1k Ω .

| | AC | ACT |
|--|---------------------|---------------------|
| Input Level | V _{CC} | 3V |
| Input Switching Voltage, V _S | 0.5 V _{CC} | 1.5V |
| Output Switching Voltage, V _S | 0.5 V _{CC} | 0.5 V _{CC} |

FIGURE 2. PROPAGATION DELAY TIMES

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PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|----------|---------------|----------------|-----------------------|----------|-------------------------------|----------------------------|--------------|------------------|
| | | | | | | (4) | (5) | | |
| CD54AC280F3A | Active | Production | CDIP (J) 14 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | CD54AC280F3A |
| CD54AC280F3A.A | Active | Production | CDIP (J) 14 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | CD54AC280F3A |
| CD54ACT280F3A | Active | Production | CDIP (J) 14 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | CD54ACT280F3A |
| CD54ACT280F3A.A | Active | Production | CDIP (J) 14 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | CD54ACT280F3A |
| CD74AC280E | Active | Production | PDIP (N) 14 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | -55 to 125 | CD74AC280E |
| CD74AC280E.A | Active | Production | PDIP (N) 14 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | -55 to 125 | CD74AC280E |
| CD74AC280M | Obsolete | Production | SOIC (D) 14 | - | - | Call TI | Call TI | -55 to 125 | AC280M |
| CD74AC280M96 | Active | Production | SOIC (D) 14 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AC280M |
| CD74AC280M96.A | Active | Production | SOIC (D) 14 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AC280M |
| CD74AC280M96G4 | Active | Production | SOIC (D) 14 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AC280M |
| CD74ACT280E | Active | Production | PDIP (N) 14 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | -55 to 125 | CD74ACT280E |
| CD74ACT280E.A | Active | Production | PDIP (N) 14 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | -55 to 125 | CD74ACT280E |
| CD74ACT280M | Obsolete | Production | SOIC (D) 14 | - | - | Call TI | Call TI | -55 to 125 | ACT280M |
| CD74ACT280M96 | Active | Production | SOIC (D) 14 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | ACT280M |
| CD74ACT280M96.A | Active | Production | SOIC (D) 14 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | ACT280M |

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF CD54AC280, CD54ACT280, CD74AC280, CD74ACT280:

● Catalog: CD74AC280, CD74ACT280

Military: CD54AC280, CD54ACT280

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD74AC280M96 | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| CD74ACT280M96 | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74AC280M96 | SOIC | D | 14 | 2500 | 353.0 | 353.0 | 32.0 |
| CD74ACT280M96 | SOIC | D | 14 | 2500 | 353.0 | 353.0 | 32.0 |

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74AC280E | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD74AC280E | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD74AC280E.A | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD74AC280E.A | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD74ACT280E | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD74ACT280E | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD74ACT280E.A | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD74ACT280E.A | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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